



FANLESS MINI COMPUTER

BCO-500-ADL

Semi-Rugged Fanless Mini Computer with Intel® Alder lake N97/i3-N305 Processor, 1x DP, 1x HDMI, 4x USB, 2x LAN



Features

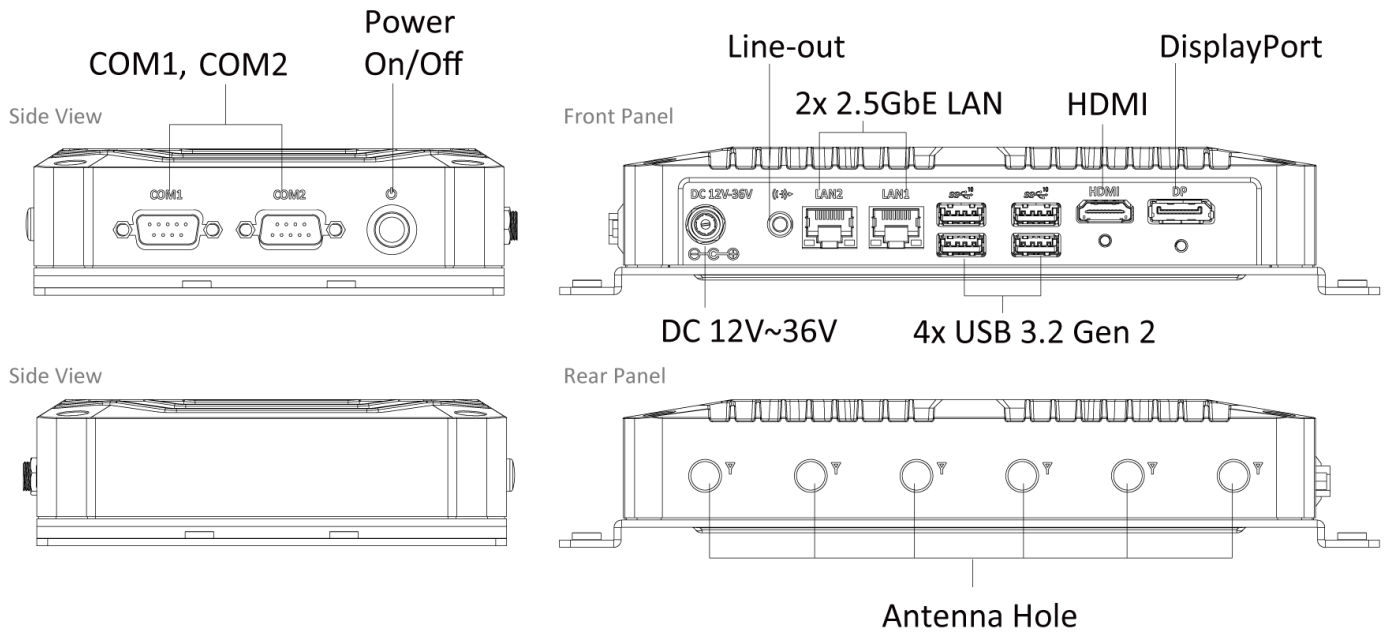
- Support Intel® Alder Lake N97/i3-N305 Processor
- 1x 262-Pin DDR5 4800MT/s SO-DIMM. Max. up to 16GB
- Dual Independent Display by 1x Display Port, 1x HDMI
- 2x Intel® I225-V 2.5GbE LAN
- 1x M.2 B-Key, 1x M.2 E-Key
- 2x COM, 4x USB 3.2, 1x Line-out
- 12 to 36VDC Wide Range Power Input Supporting AT/ATX Mode
- Wide Operating Temperature N97 CPU/12W (-10°C to 50°) and N305 CPU/15W (-10°C to 45°)
- TPM 2.0 Supported
- CE, FCC Class A, UL, VCCI, RCM

Specifications

System	
Processor	<ul style="list-style-type: none"> • 12th Gen Intel® IoTG Alder Lake-N Processor N97, QC, 12W • 12th Gen Intel® IoTG Alder Lake-N Processor i3-N305, QC, 15W
System Chipset	SoC integrated
LAN Chipset	2 x Intel® I225-V 2.5GbE LAN
Audio Codec	Realtek ALC897
System Memory	1x 262-Pin DDR5, 4800MHz SO-DIMM, Max. up to 16GB (Non-ECC)
BIOS	AMI uEFI BIOS
Watchdog	Software Programmable Supports 1~255 sec. System Reset
TPM	TPM 2.0
Display	
Display Port	1 x DisplayPort 1.4a, Max Resolution 4096 x 2304 @60Hz
HDMI	1 x HDMI 1.4b, Max Resolution 3840 x 2160 @30Hz
Multiple Display	2x Independent Displays
Storage	
M.2 B-Key	1 x M.2 B Key (2242/2280/3042, SATA/PCIe x1 support SATA/NVMe)
Expansion	
M.2	1 x M.2 E Key (2230, PCIe x1, USB 2.0 for Wifi/Bluetooth)
I/O	
DisplayPort	1x DisplayPort
HDMI	1 x HDMI
COM	2x DB9 COM1: RS232/422/485 COM2: RS232
USB	4x USB 3.2 Gen 2 (10 Gbps)
LAN	2x RJ45 2.5GbE LAN Ports Connectors
Audio	1x Line-out
Others	6x Antenna Holes 1x Power button 1x DC in Power Jack with Lock
Operating System	
Windows	Windows 10 / Windows 11
Linux	Linux kernel
Power	
Power Adapter	Adapter 60W (optional)
Power Mode	AT, ATX (Default ATX)
Power Supply Voltage	12~36VDC
Power Connector	DC in Power Jack with Lock
Environment	
Operating Temperature	N97 CPU: -10°C to 50°C (12W) i3-N305 CPU: -10°C to 45°C (15W)
Storage Temperature	-30°C to 85°C

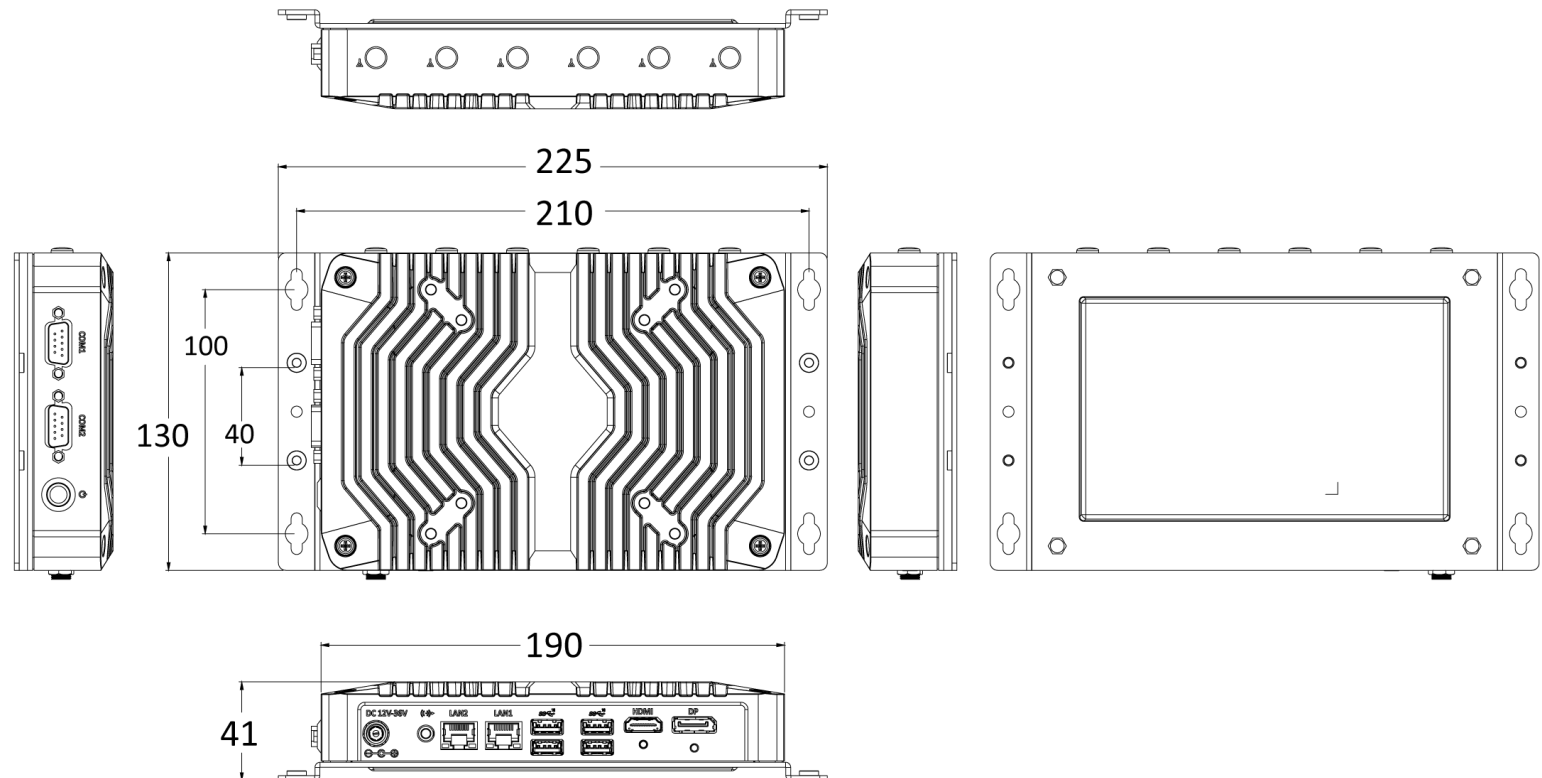
Relative Humidity	10% to 95% (non-condensing)
Certification	UL 61010-2-201, CE, FCC Class A, VCCI, RCM
Vibration	With SSD: 5 Grms (5 - 500 Hz, 0.5 hr/axis)
Shock	With SSD: 50G half-sin 11ms
Physical	
Dimensions	225 (W) x 130 (D) x 41 (H) mm
Weights	3KG
Construction	Extruded Aluminum with Heavy Duty Metal
Mounting Options	Wall Mounting Din-Rail Mounting (Optional)

External I/O Mechanical Layout



Dimension

Unit: mm



Available Models

Model No.	Description
BCO-500-ADL-2L-N97	Fanless Mini Industrial Computer with Intel® Alder Lake N97, QC, 12W Processor, 1x DP, 1x HDMI, 4x USB, 2x LAN
BCO-500-ADL-2L-N305	Fanless Mini Industrial Computer with Intel® Alder Lake i3-N305, QC, 15W Processor, 1x DP, 1x HDMI, 4x USB, 2x LAN

Optional Accessories

Model No.	Description
1-TPCD00005	Power Cord, 3-pin US Type, 180cm
1-TPCD00002	Power Cord, European Type, 180cm
1-TPCD00001	Power Cord, 3-pin UK Type, 180cm
3-BC5AD110S10-S0	Din-Rail Mounting Kit
3-BC5AD020S10-S0	M.2 B KEY Thermal Kit

Packing List

1x BCO-500-ADL Series Fanless Mini Computer
1x Accessory Kit

Compliances and Standards

Shock	With SSD: 50G half-sin 11ms IEC60068-2-27:2008 Designed to comply with MIL-STD-810G Method 516.7 Procedure I
Vibration	With SSD: 5 Grms (5 - 500 Hz, 0.5 hr/axis) IEC60068-2-64:2008 Designed to comply with MIL-STD-810G Method 514.7 Procedure I
Operating Temperature	N97 CPU: -10°C to 50°C (12W) i3-N305 CPU: -10°C to 45°C (15W) IEC60068-2-1:2007 (Cold test procedure) IEC60068-2-2:2007 (Dry heat test procedure) IEC60068-2-3:2007 (Damp heat, steady state, test procedure) IEC60068-2-14:2009 (Wide temperature range thermal shock)
EMI	<ul style="list-style-type: none"> • FCC Class A (47 CFR part 15.109 and part 15.107) • CE • ICES-003 • UKCA
Safety	<ul style="list-style-type: none"> • UL Safety: UL 61010-2-201 • Test procedure: CB Scheme • Standard: IEC 61010-2-201:2024